

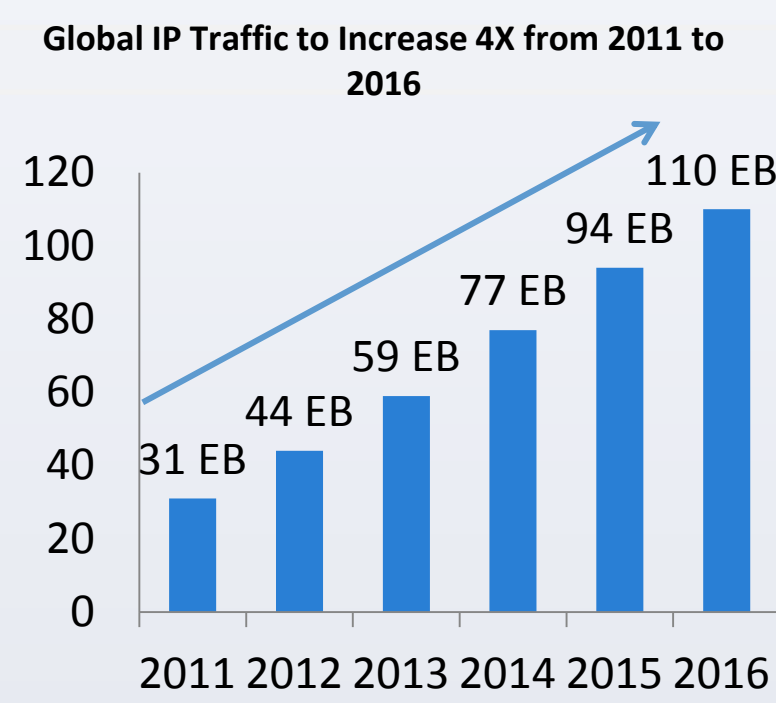


Silicon photonics and Novel Materials for Datacenters and Cloud Computing



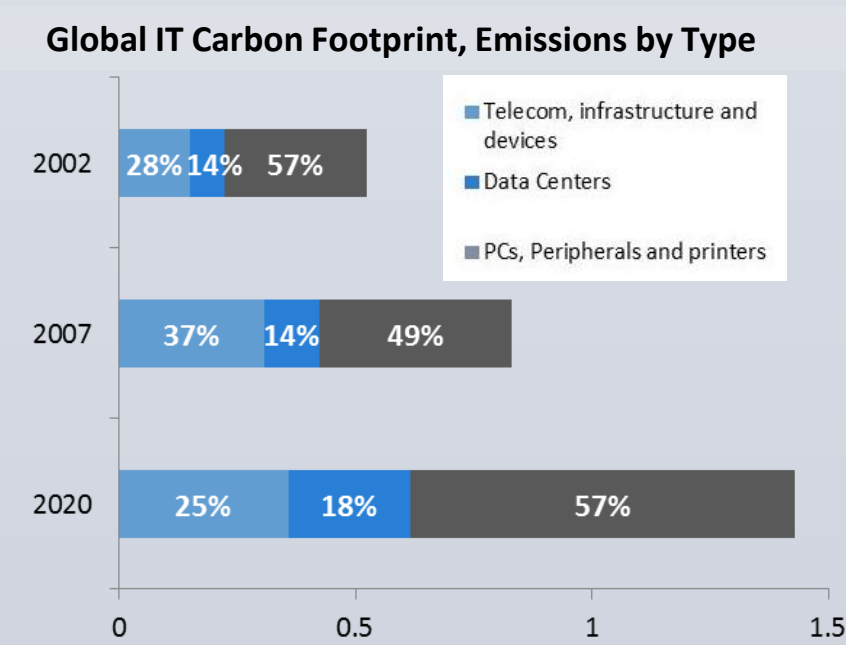
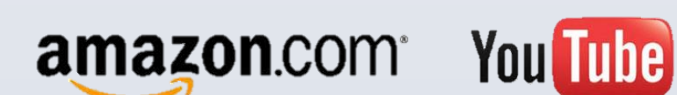
Xiaoliang Zhu and Tingyi Gu
Columbia University

The problem:



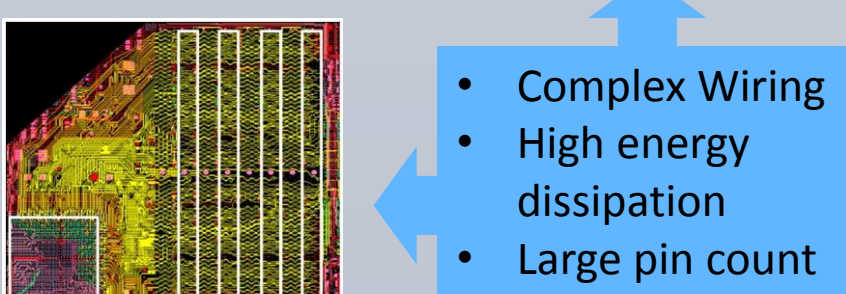
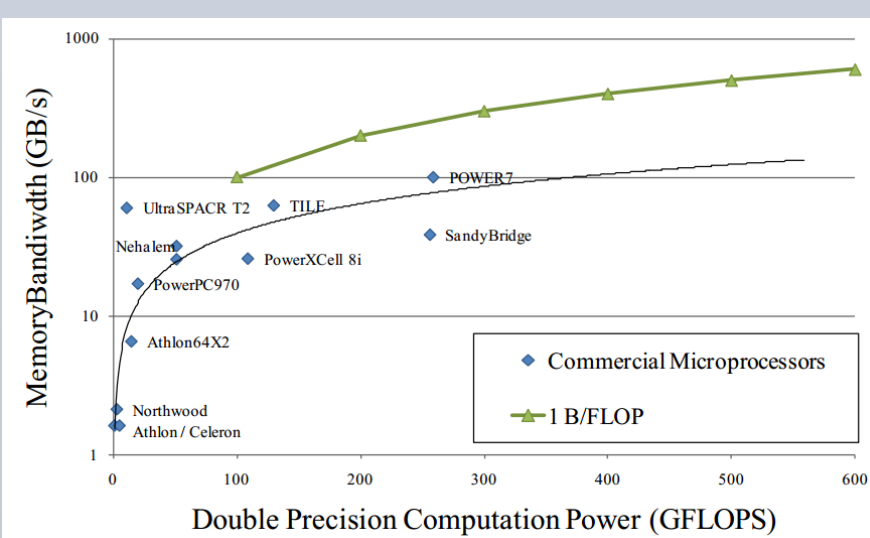
There is tremendous growth in internet traffic and bandwidth demand due to the emergence of cloud computing, social media and internet video streaming applications.

- This leads to service providers to build data centers on a huge scale.

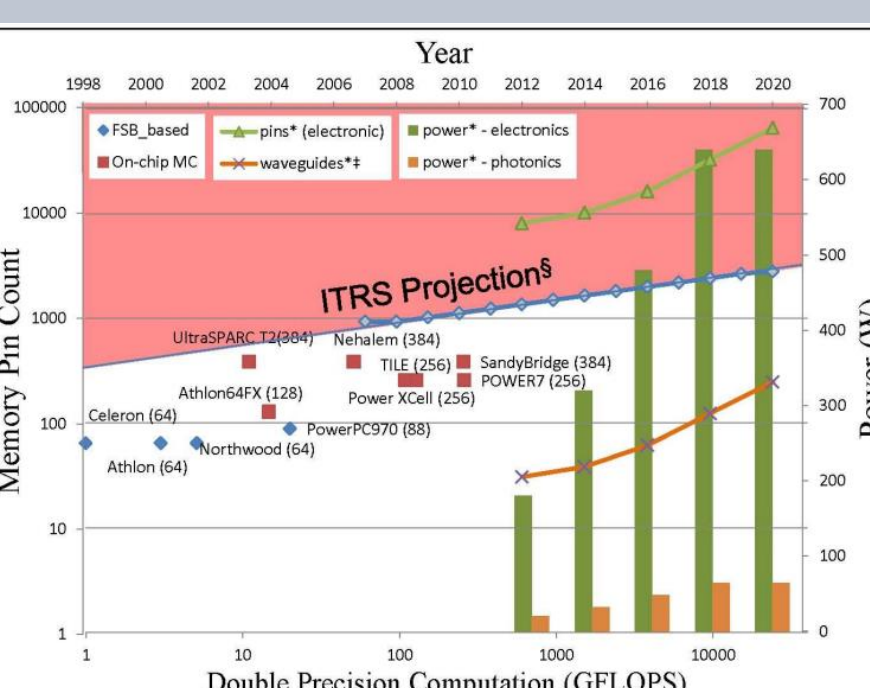


- The demand means ever-growing energy usage and green-house gas emissions. Global IT already has a greater carbon footprint than the airline industry.

Improving computational performance and efficiency is key to reducing emissions



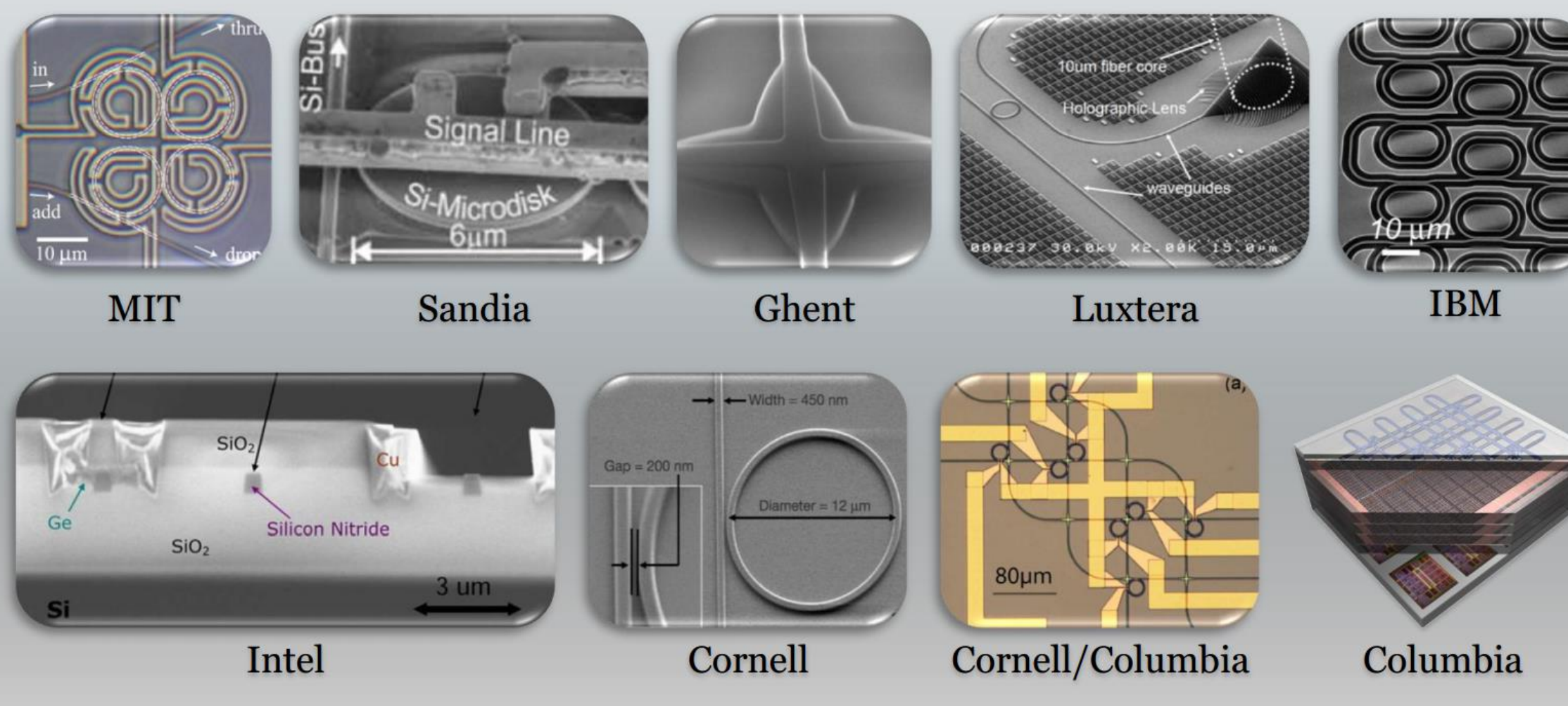
- However it is becoming difficult to improve computational efficiency using electronics.
- There is a bottleneck to send data from the CPU to memory or other computers.
- Combining optics with electronics can offer dramatic improvements in efficiency, as well as increases in performance



Silicon photonics vision:

Leverage the tremendous bandwidth available in fiber optic communications to solve CPU-memory and datacenter scale communication bottlenecks.

Silicon-on-insulator (SOI) platform photonic building blocks:
High index contrast enables high confinement, low-loss propagation, virtually lossless bending



Current efforts are on-going to make nano-structures that can manipulate light to replace electronic wires, filters, modulators, detectors, and switches, as well as coming up with new system designs leveraging photonics.

Commercial integration is nearly ready

Hybrid platforms: Intel

Monolithic CMOS Integration: IBM, ORACLE

Transceivers for Datacom: LUXTERA, LIGHTWIRE

Academic Foundry Services: imec, Institute of Microelectronics, OPSIS

- Standardized manufacturing
- Component libraries
- Layout tools
- Wafer level processing and test

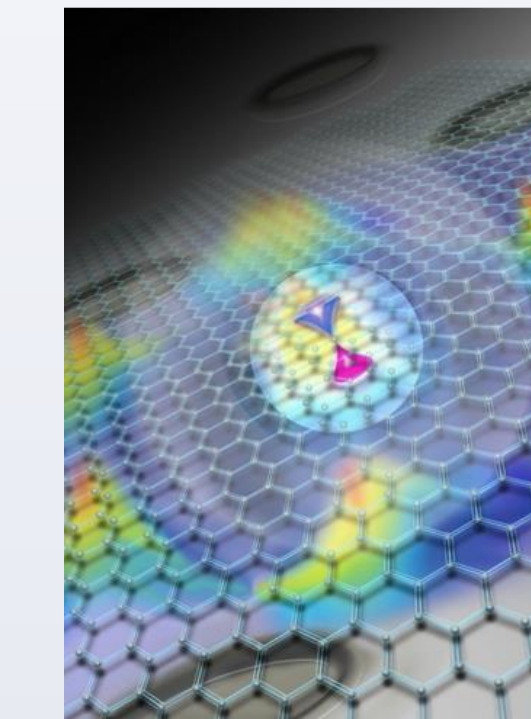
Commercially available active optical cables:

- USB 3.0
- Thunderbolt
- 40 Gb/s Ethernet cable

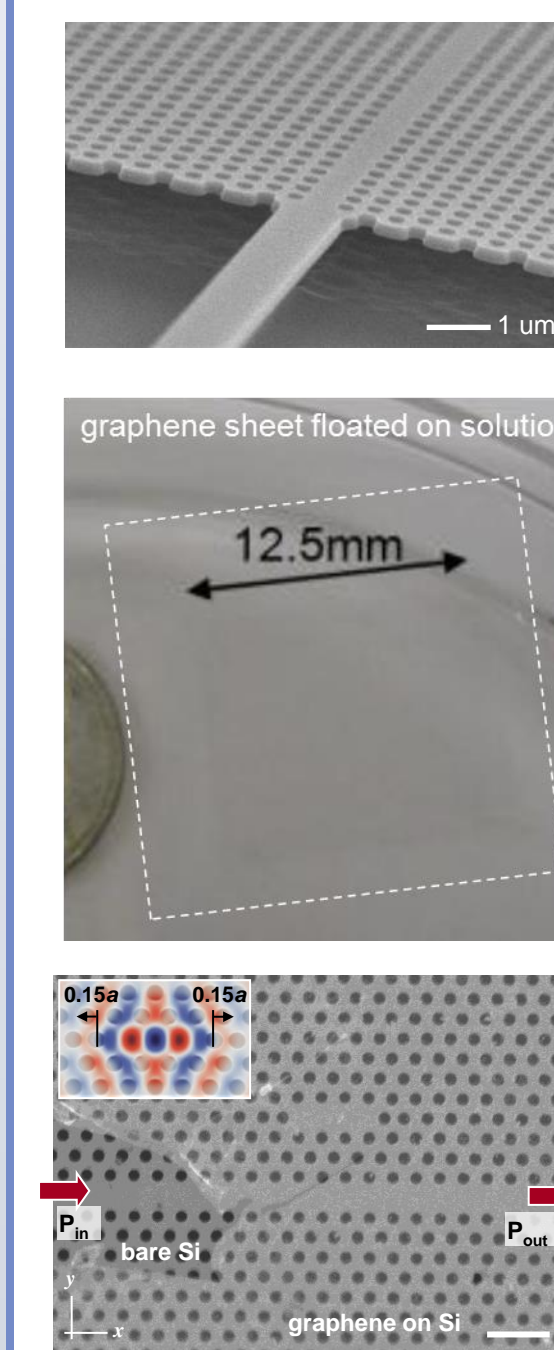
Maturing packaging technology:

- PLC Connections Edge Coupling To Optics Test Chip
- Optical Photonics Edge Coupling Package 120 I/Os
- PLC Connections Vertical Mounting Package 3.6M I/Os

IGERT at Columbia

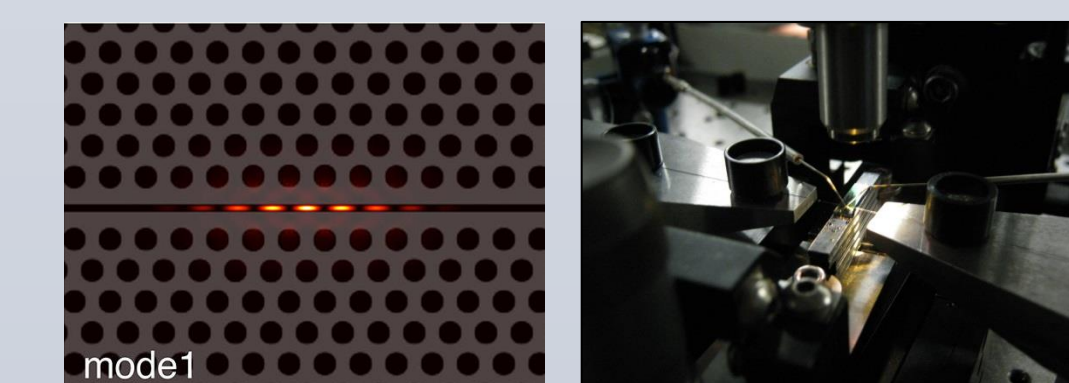


- Cross-disciplinary approach allow us to explore performance of novel structures and materials not examined before in Silicon Photonics.
- These materials offers intriguing properties for even higher performance and lower power consumption in Silicon Photonics.



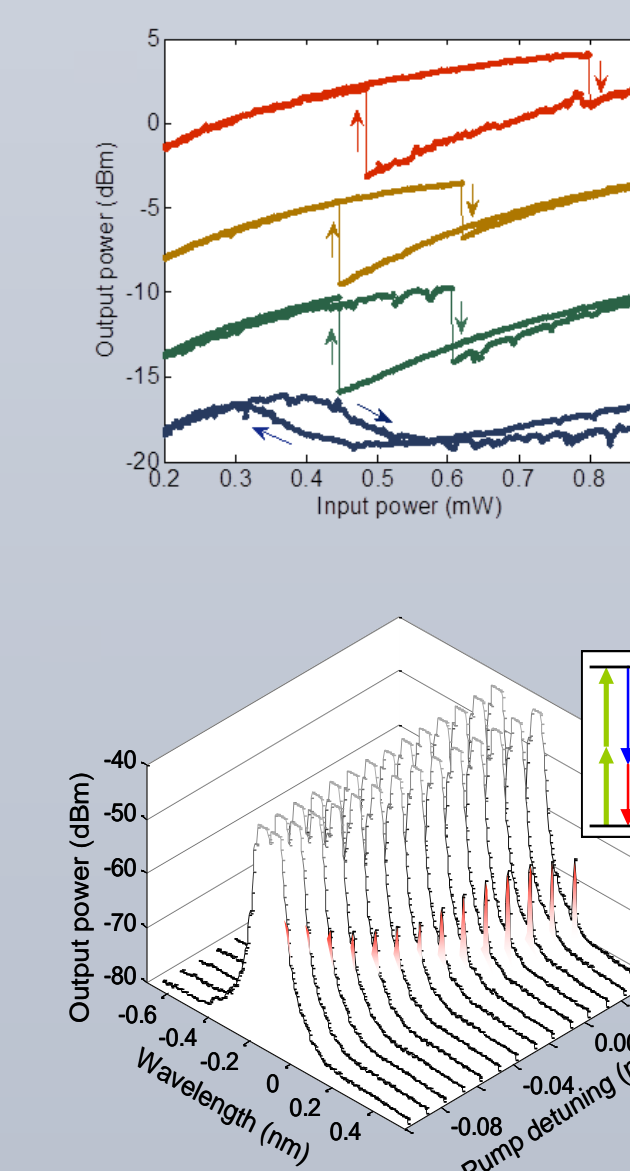
Fabrication of graphene on air-bridged silicon photonic crystal membranes:

- First fabricate photonic crystal and waveguide on SOI using electron beam lithography and reactive ion etching
- Next grow graphene using chemical vapor deposition
- Transfer graphene by floating membrane on wet solution then drying
- Monolayer of graphene is deposited on the photonic crystal
- Light is strongly confined to waveguide region



Our collaboration allows us to leverage strengths in both device physics and systems level electrical characterization

Results



- Femto-joule optical bistabilities - steady-state hysteresis, useful for dynamic optical switching
- Optical nonlinearities in hybrid graphene-silicon cavities - enhanced Kerr and two-photon absorption observed
- Graphene-Si: cavity four-wave mixing - observations possible due to strong optical confinement, effective n_2 calculations and coupled-mode theory comparison to simulation

